# **AN8062**

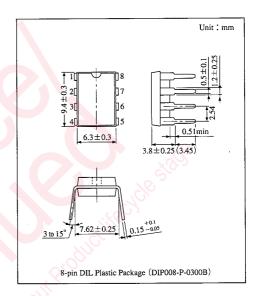
# Low Drop-out Positive Output Voltage Regulator with Reset Pin

#### Overview

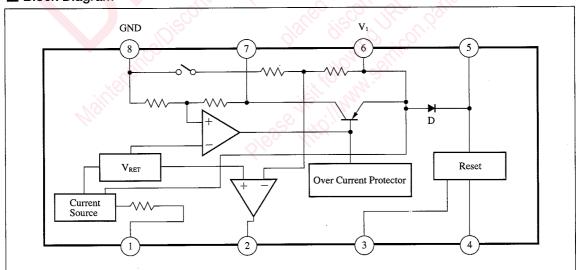
The AN8062, which incorporates output ON/OFF switchable strobe, reduced voltage detection, and microcomputer reset functions, is a voltage regulator IC with small minimum input/output voltage difference and optimum for battery operation.

#### **■** Features

- 30mA output current and 4V fixed output voltage
- Minimum input/output voltage difference: typ. 0.1V (I<sub>OUT</sub>=10mA)
- Capable of turning on the output by grounding the strobe pin
- Provided with the reduced voltage detection pin which detects and outputs reduction of an input voltage, and the reset pin which resets the microcomputer, etc.



## Block Diagram



## ■ Absolute Maximum Ratings (Ta=25°C)

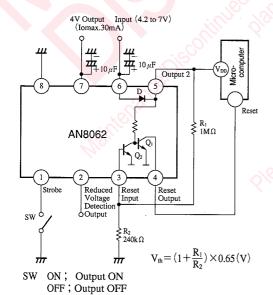
Parameter	Symbol	Rating	Unit	
Input voltage	VI	12	V	
Power dissipation	P <sub>D</sub>	500	mW	
Operating ambient temperature	Topr	-20  to  +75	℃	
Storage temperature	$T_{ m stg}$	-55  to  +150	ో	

#### ■ Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Rating	min	typ	max	Unit
Bias current at reset	$I_{RB}$	$V_R=6V, V_I=6V$			10	μΑ
Bias current at no load	$I_{VB}$	$V_R=0V, V_I=6V$		1.7	4	mA
Output voltage	Vo	$V_I=6V, I_O=3mA$	3.84	4	4.16	V
Output voltage tolerance	V <sub>T</sub>	$V_1$ =4.3 to 7V, $I_0$ =1 to 10mA	3.82		4.18	V
Line regulation	REG <sub>IN</sub>	$V_{I} = 4.3 \text{ to 7V}, I_{O} = 3\text{mA}$	) —	3	30	mV
Load regulation	REGL	$V_{I} = 6V, I_{O} = 1 \text{ to } 10\text{mA}$		1	30	mV
Input/output voltage difference	V <sub>IOS</sub>	$V_{I} = 3.8V, I_{O} = 10mA$		0.1	0.2	V
Strobe pin input current (H)	I <sub>RIC(H)</sub>	$V_R=6V, V_I=6V$	-1		1	μΑ
Strobe pin input current (L)	I <sub>RIC(L)</sub>	$V_R = 0V, V_I = 6V$	-200			μΑ
Reduced voltage detection level	V <sub>RDL</sub>	I <sub>O</sub> =3mA	3.95	4.20	4.45	V
Output voltage at reset	V <sub>RO</sub>	$V_R=6V, V_I=6V$			0.1	V
CPU reset output suction current	$I_{CR}$	$V_{I}=2.5V, V_{R}=0.4V$	40			μΑ
Hysteresis width	V <sub>H</sub>	I <sub>O</sub> =3mA		60		mV
Diode voltage drop	$V_{D}$	I <sub>O</sub> =3mA	<del>- 2</del>	0.7		o v
Overcurrent protection	I <sub>OCP</sub>	$V_I=6V, V_R=0V$		45	coll l	mA
Output voltage temperature coefficient	ΔV <sub>0</sub> /ΔΤ	$V_{I}=6V, I_{O}=3mA$ $T_{A}=0 \text{ to } 50^{\circ}C$	9,77	-20		ppm/℃



## Application Circuit



## Description of Functioning

#### 1. Functioning of the strobe pin

When the strobe pins grounded, 4V (typ.) is output to the output pin 1 (Pin⑦). If this pin is opened, the circuits other than reset output (Pin④) output 2 (Pin⑤) are turned off

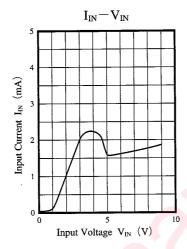
#### 2. Function of the reduced voltage detection pin

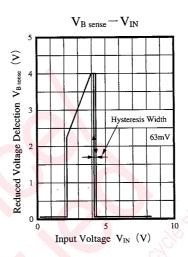
When the input voltage of the input pin (Pin( $\hat{e}$ )) drops to 4.2V (typ.), the reduced voltage detection pin (Pin( $\hat{e}$ )) is switched from "L" to "H" (same voltage level as input). There is 60mV (typ.) hysteresis at the end of "H" to "L" switching.

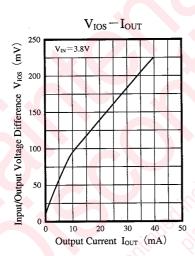
#### 3. Function of the output pin 2

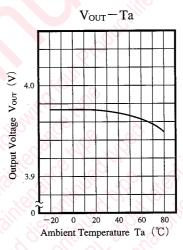
When the voltage  $(V_{DD}$  of the microcomputer) level of the output 2 drops below Vth, the transistor  $(Q_2)$  for reset output is turened on and reset output (Pin 4) is set to the "L" level. This causes the reset function to reset the microcomputer.

# ■ Characteristics Curve









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